



HMC308 / 308E

GENERAL PURPOSE 100 mW GaAs MMIC AMPLIFIER, 0.8 - 3.8 GHz

Typical Applications

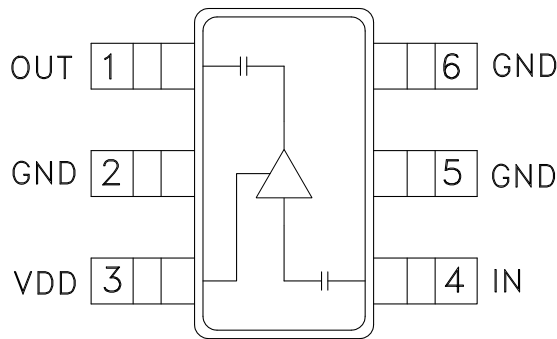
Broadband or Narrow Band Applications:

- Cellular/PCS/3G
- Fixed Wireless & Telematics
- Cable Modem Termination Systems
- WLAN, Bluetooth & RFID

Features

- Gain: 18 dB
- P1dB Output Power: +17 dBm@ +5V
- Single Supply: +3V or +5V
- No External Components
- Integrated DC Blocks
- Ultra Small Package: SOT26

Functional Diagram



General Description

The HMC308 & HMC308E are low cost MESFET MMIC amplifiers that operate from a single +3 to +5V supply from 0.8 to 3.8 GHz. The surface mount SOT26 amplifier can be used as a broadband amplifier stage or used with external matching for optimized narrow band applications. With Vdd biased at +5V, the HMC308 & HMC308E offers 18 dB of gain and +20 dBm of saturated output power while requiring only 53 mA of current. This amplifier is ideal as a driver amplifier for transmitters or for use as a local oscillator (LO) amplifier to increase drive levels for passive mixers. The amplifier occupies 0.014 in² (9 mm²), making it ideal for compact radio designs.

Electrical Specifications, $T_A = +25^\circ C$, as a function of Vdd

| Parameter | Vdd = +3V | | | Vdd = +5V | | | Vdd = +5V | | | Vdd = +5V | | | Units |
|--|-----------|-------|-------|-----------|-------|-------|-----------|-------|-------|-----------|-------|-------|-------|
| | Min. | Typ. | Max. | Min. | Typ. | Max. | Min. | Typ. | Max. | Min. | Typ. | Max. | |
| Frequency Range | 2.3 - 2.7 | | | 0.8 - 2.3 | | | 2.3 - 2.7 | | | 2.7 - 3.8 | | | GHz |
| Gain | 13 | 15.5 | | 14 | 18 | | 13 | 16 | | 10 | 13 | | dB |
| Gain Variation over Temperature | | 0.025 | 0.035 | | 0.025 | 0.035 | | 0.025 | 0.035 | | 0.025 | 0.035 | dB/°C |
| Input Return Loss | | 11 | | | 8 | | | 11 | | | 13 | | dB |
| Output Return Loss | | 17 | | | 13 | | | 12 | | | 13 | | dB |
| Output Power for 1 dB Compression (P1dB) | 12 | 14 | | 14 | 17 | | 13.5 | 16.5 | | 12 | 15 | | dBm |
| Saturated Output Power (Psat) | | 17 | | | 20 | | | 19.5 | | | 17 | | dBm |
| Output Third Order Intercept (IP3) | 23 | 26 | | 27 | 30 | | 26 | 29 | | 24 | 27 | | dBm |
| Noise Figure | | 7 | | | 7.5 | | | 7 | | | 7 | | dB |
| Supply Current (Idd) | | 50 | | | 53 | | | 53 | | | 53 | | mA |

For price, delivery, and to place orders, please contact Hittite Microwave Corporation:

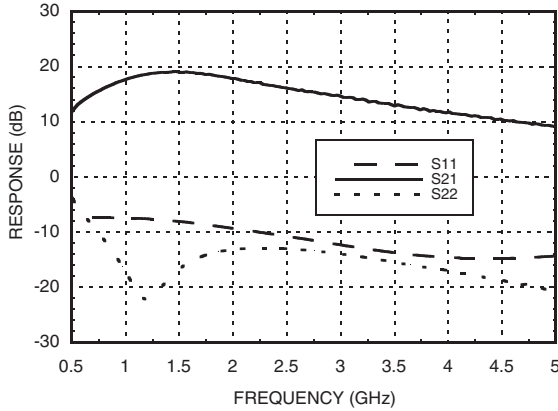
SUNSTAR 微波光电 <http://www.rfoc.net/> TEL:0755-83396822 FAX:0755-83376182 E-MAIL: szss20@163.com
Order On-line at www.hittite.com



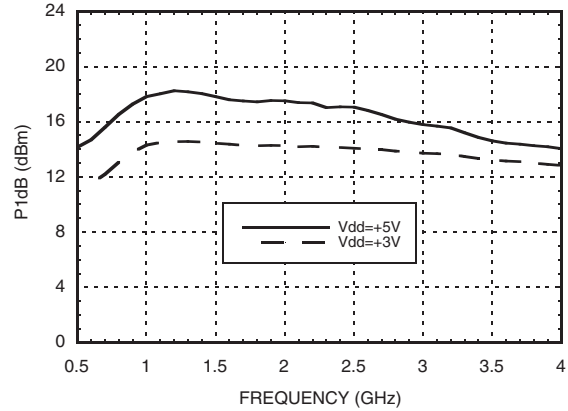
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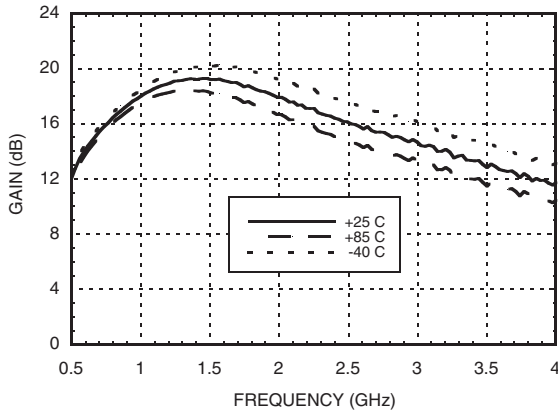
Broadband Gain & Return Loss @ Vdd = +5V



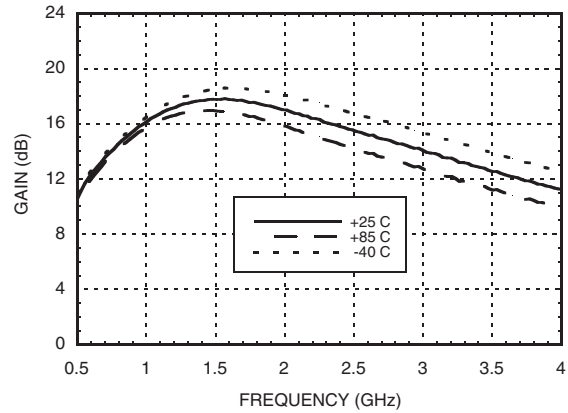
P1dB vs. Vdd Bias



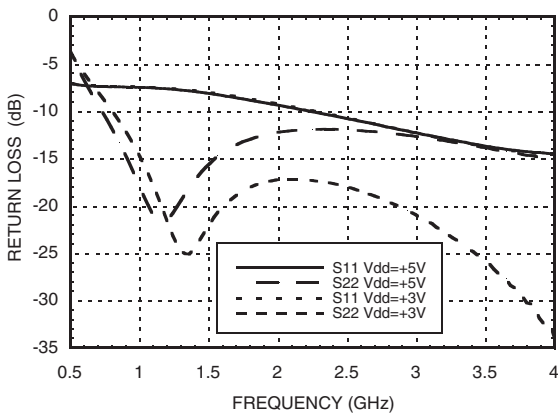
Gain vs. Temperature @ Vdd = +5V



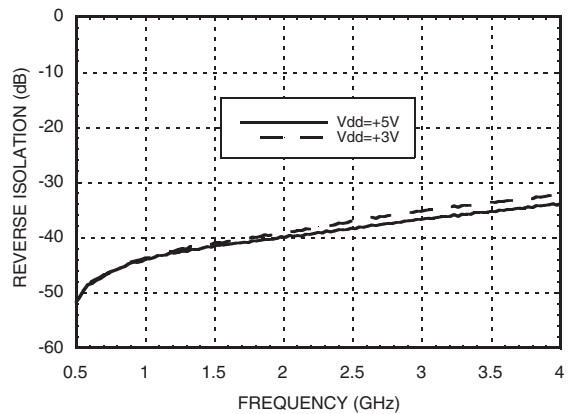
Gain vs. Temperature @ Vdd = +3V



Input & Output Return Loss vs. Vdd Bias



Reverse Isolation vs. Vdd Bias

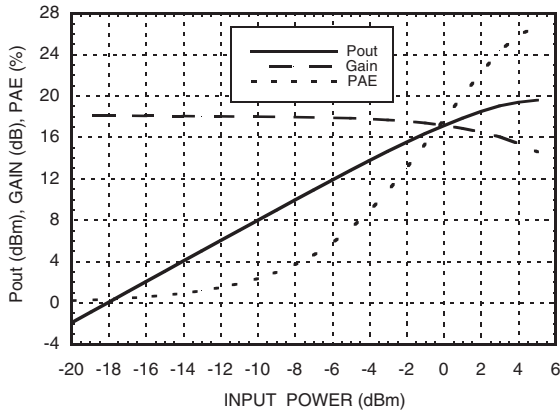




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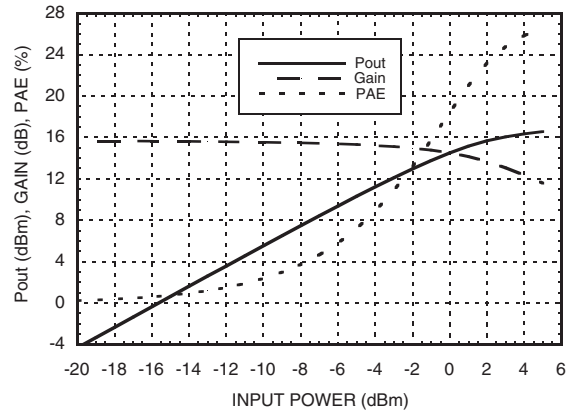
Power Compression @ 2.0 GHz, Vdd = +5V



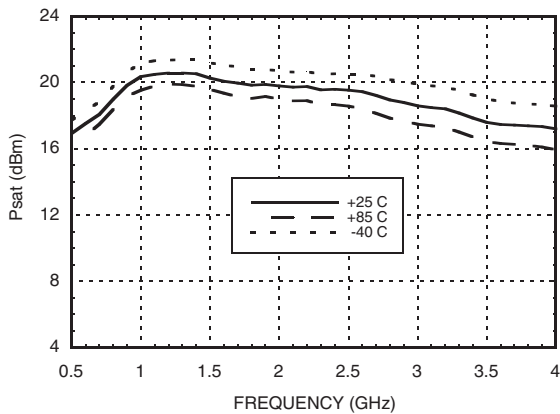
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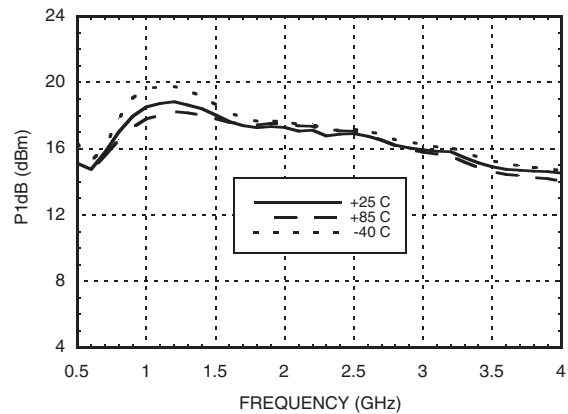
Power Compression @ 2.5 GHz, Vdd = +5V



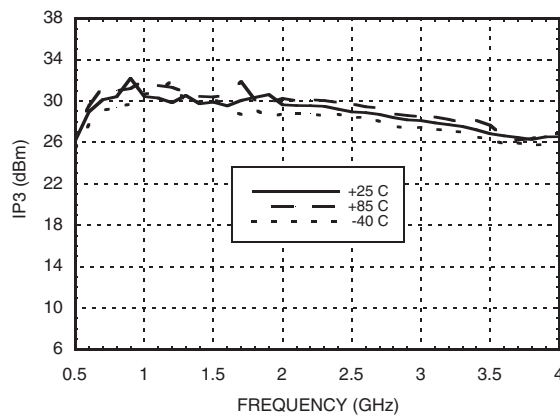
Psat vs. Temperature @ Vdd = +5V



Output P1dB vs. Temperature @ Vdd = +5V



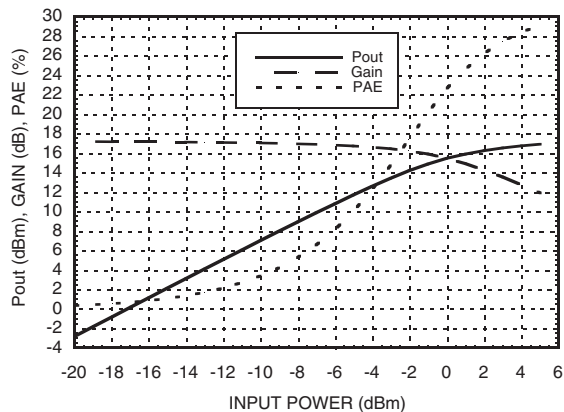
Output IP3 vs. Temperature @ Vdd = +5V



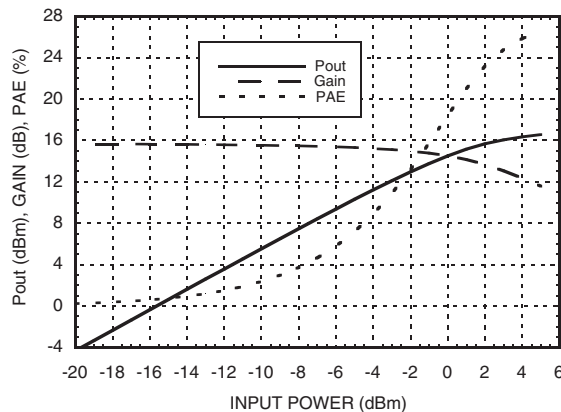
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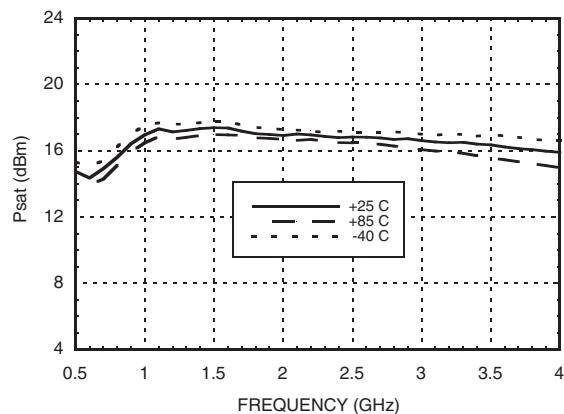
Power Compression
@ 2.0 GHz, Vdd = +3V



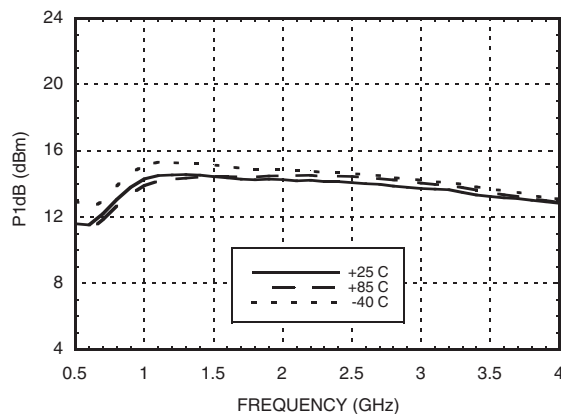
Power Compression
@ 2.5 GHz, Vdd = +3V



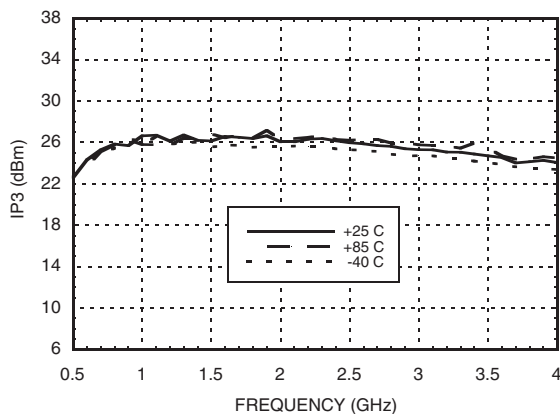
Psat vs. Temperature @ Vdd = +3V



Output P1dB vs. Temperature @ Vdd = +3V



Output IP3
vs. Temperature @ Vdd = +3V



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Absolute Maximum Ratings

| | |
|---|----------------|
| Drain Bias Voltage (Vdd) | +7.0 Vdc |
| RF Input Power (RFIN)(Vdd = +5.0 Vdc) | +10 dBm |
| Channel Temperature | 150 °C |
| Continuous Pdiss (T = 85 °C) (derate 6.25 mW/°C above 85 °C) | 0.406 W |
| Thermal Resistance (channel to lead) | 160 °C/W |
| Storage Temperature | -65 to +150 °C |
| Operating Temperature | -40 to +85 °C |
| ESD Sensitivity (HBM) | Class 1A |

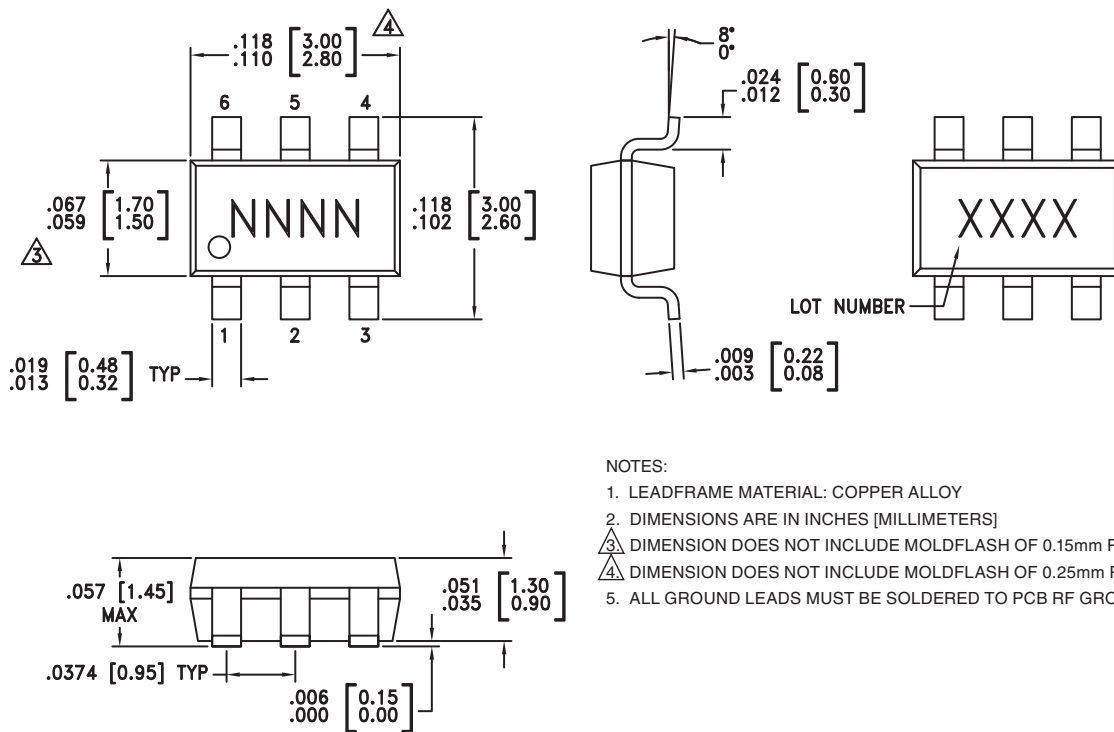
Typical Supply Current vs. Vdd

| Vdd (Vdc) | Idd (mA) |
|-----------|----------|
| +2.5 | 49 |
| +3.0 | 50 |
| +3.5 | 51 |
| +4.5 | 50 |
| +5.0 | 53 |
| +5.5 | 54 |



ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Outline Drawing



NOTES:

- LEADFRAME MATERIAL: COPPER ALLOY
- DIMENSIONS ARE IN INCHES [MILLIMETERS]
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.15mm PER SIDE.
- DIMENSION DOES NOT INCLUDE MOLDFLASH OF 0.25mm PER SIDE.
- ALL GROUND LEADS MUST BE SOLDERED TO PCB RF GROUND

Package Information

| Part Number | Package Body Material | Lead Finish | MSL Rating | Package Marking ^[3] |
|-------------|--|---------------|---------------------|--------------------------------|
| HMC308 | Low Stress Injection Molded Plastic | Sn/Pb Solder | MSL1 ^[1] | H308 XXXX |
| HMC308E | RoHS-compliant Low Stress Injection Molded Plastic | 100% matte Sn | MSL1 ^[2] | 308E XXXX |

[1] Max peak reflow temperature of 235 °C
 [2] Max peak reflow temperature of 260 °C
 [3] 4-Digit lot number XXXX

For price, delivery, and to place orders, please contact Hittite Microwave Corporation:

SUNSTAR 微波光电 <http://www.rfoc.net/> TEL:0755-83396822 FAX:0755-83376182 E-MAIL: szss20@163.com
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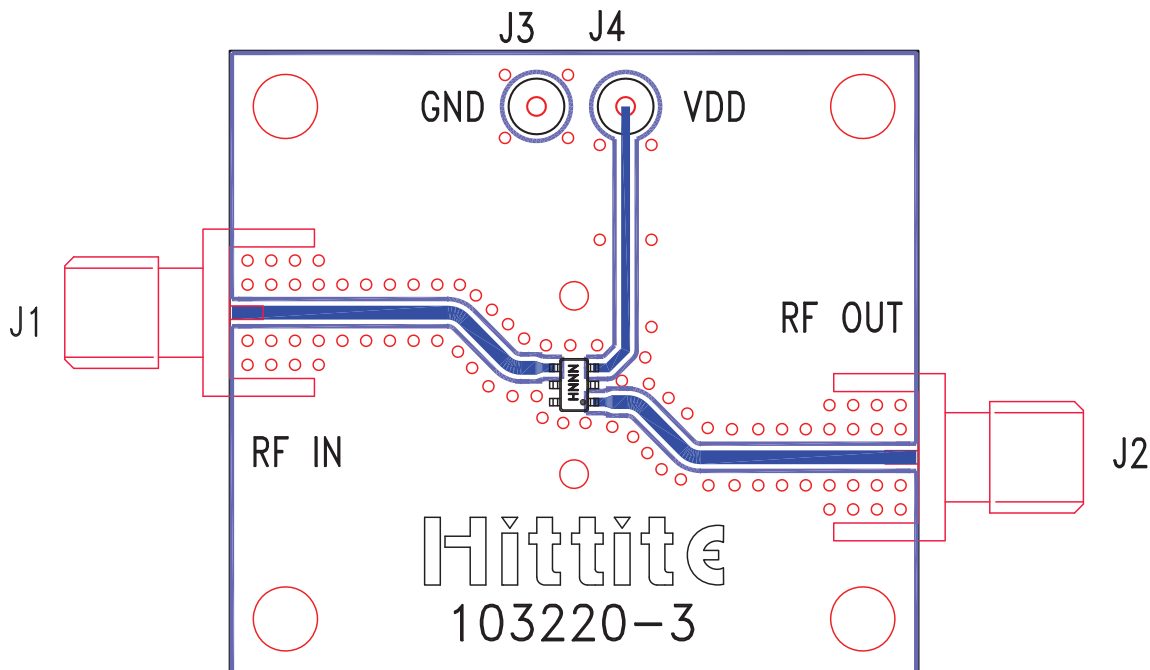
Pin Descriptions

| Pin Number | Function | Description | Interface Schematic |
|------------|----------|--|---------------------|
| 1 | RFOUT | This pin is AC coupled and matched to 50 Ohms. | |
| 2, 5, 6 | GND | These pins must be connected to RF/DC ground. | |
| 3 | Vdd | Power supply voltage. | |
| 4 | RFIN | This pin is AC coupled and matched to 50 Ohms. | |

Evaluation PCB

5

DRIVER & GAIN BLOCK AMPLIFIERS - SMT



List of Materials for Evaluation PCB 103802 [1]

| Item | Description |
|---------|----------------------------|
| J1, J2 | PCB Mount SMA Connector |
| J3, J4 | DC Pins |
| U1 | HMC308 / HMC308E Amplifier |
| PCB [2] | 103220 Evaluation Board |

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Roger 4350

The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package ground leads should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.



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Notes: